

300mA Ultra-low Noise, Ultra-Fast CMOS LDO Regulator

FEATURES

- Ultra-low Noise
- Ultra-Fast Response in Line/Load Transient
- 0.01μA Standby Current When Shutdown
- Low Dropout: 205mV@300mA
- Wide Operating Voltage Ranges: 2.2V to 6V
- Low Temperature Coefficient
- Current Limiting Protection
- Thermal Shutdown Protection
- Only 1µF Output Capacitor Required for Stability
- High Power Supply Rejection Ratio
- Fast output discharge
- Available in SOT23-5, SOT23-3, SC70-5 and DFN1×1-4L Package

APPLICATIONS

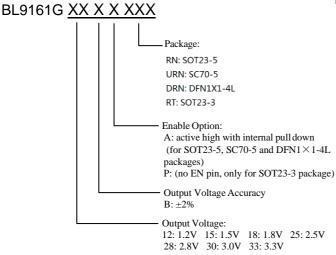
- Cellular and Smart Phones
- Cordless Telephones
- Battery-Powered Equipment
- Laptop, Palmtops, Notebook Computers

- Hand-Held Instruments
- PCMCIA Cards
- MP3/MP4/MP5 Players
- Portable Information Appliances

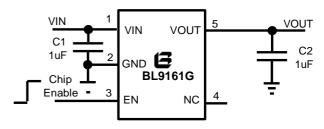
DESCRIPTION

The BL9161G is designed for portable applications with demanding performance and space requirements. The BL9161G performance is optimized for battery-powered systems to deliver ultra low noise and low quiescent current. Regulator ground current increases only slightly in dropout, further prolonging the battery life. The BL9161G also works with low-ESR ceramic capacitors, reducing the amount of board necessary for power applications, critical in hand-held wireless devices. The BL9161G consumes only 0.01µA current in shutdown mode and has fast turn-on time (Typical 50µs). The other features include ultra low dropout voltage, high output accuracy, current limiting protection, and high ripple rejection ratio.

ORDERING INFORMATION



TYPICAL APPLICATION



Application hints:

Output capacitor (C2 \geq 2.2uF) is recommended in BL9161G-1.2V, BL9161G-1.5V and BL9161G-1.8V application to assure the stability of circuit.



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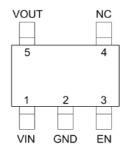
Absolute Maximum Rating (Note 1)

Input Supply Voltage (VIN) EN Pin Input Voltage Output Voltages Output Current

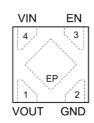
-0.3V to +6V -0.3V to VIN -0.3V to VIN+0.3V 300mA Maximum Junction Temperature 150°C
Operating Temperature Range (Note2) -40°C to 85°C
Storage Temperature Range -65°C to 125°C
Lead Temperature (Soldering, 10s) 300°C

PIN CONFIGURATIONS

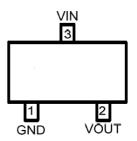
SOT23-5 &SC70-5(TOP VIEW)



DFN1X1-4L(TOP VIEW)

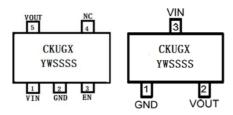


SOT23-3(TOP VIEW)



Package Marking

SOT23-5 & SC70-5 SOT23-3



DFN1×1-4L



Thermal Resistance (Note 3):

Package	Θ_{JA}	Θ^{C}
SOT23-5	250℃/W	130℃/W
SC70-5	333°C/W	170°C/W

CKUG: Chip ID
X: Output voltage
Y: Data code—Year
W: Data code—Week

G: Chip ID

X: Output voltage
W: Data code—Week

Output voltage	1.2V	1.5V	1.8V	2.5V	2.8V	3.0V	3.3V
X(SOT23-5, SOT23-3& SC70-5)	В	С	D	E	G	I	К
X(DFN1×1-4L)	В	С	D	E	G	1	K

Υ	4	5	6	 0	1	
Year	2014	2015	2016	 2020	2021	

W	Α	 Υ	Z	а	 У	Z
Week	1	 25	26	27	 51	52

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: The BL9161G is guaranteed to meet performance specifications from 0°C to 70°C. Specifications over the – 40°C to 85°C operating temperature range are assured by design, characterization and correlation withstatistical process controls.

Note 3: Thermal Resistance is specified with approximately 1 square of 1 ozcopper.



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Pin Description

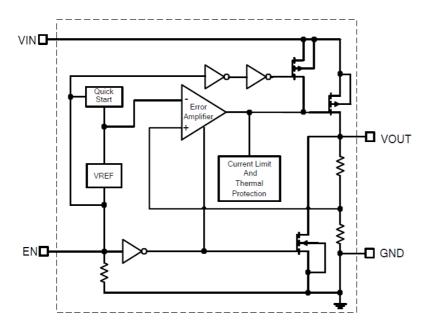
SOT23-5 . SC70-5 & SOT23-3

PIN			
SOT23-5 &SC70-5		NAME	FUNCTION
1	3	VIN	Power Input Voltage.
2	1	GND	Ground.
3		EN	Chip Enable Pin, This pin has an internal pull-down resistor
4		NC	No Connection.
5	2	VOUT	Output Voltage.

DFN1X1-4L

PIN	NAME	FUNCTION
1	VOUT	Output Voltage.
2	GND	Ground.
3	EN	Chip Enable Pin, This pin has an internal pull-down resistor
4	VIN	Power Input Voltage.
Exposed		The exposed pad should be connected to a large ground plane to
Pad		maximize thermal performance.

Block Diagram





300mA Ultra-low Noise, Ultra-Fast CMOS LDO Regulator

Electrical Characteristics (Note 4)

(V_{IN} =Vout +1V, EN= V_{IN} , C_{IN} = C_{OUT} =1 μ F, T_A =25 $^{\circ}$ C, unless otherwise noted.)

Parameter		Symbol	Conditions	MIN	TYP	MAX	unit
Inpu	t Voltage	V _{IN}		2.2		6	V
Output Voltage Accuracy		ΔV_{OUT}	V _{IN=} Vout+1V, I _{OUT} =1mA	-2		+2	%
Cur	rent Limit	I _{LIM}	$R_{LOAD}=1\Omega$	360	450		mA
Quieso	ent Current	ΙQ	V _{EN} >1.2V, I _{OUT} =0mA		70	110	μΑ
Drong	out Voltage	V_{DROP}	I_{OUT} =200mA, V_{OUT} =3.3V		135	200	- mV
Бторс	out voltage	V DROP	I_{OUT} =300mA, V_{OUT} =3.3V		205	300	IIIV
Line Reg	gulation ^(Note 5)	ΔV_{LINE}	V _{IN} =Vout+1V to 5.5V		0.02	0.17	%/V
			I _{OUT} =1mA				
Load Re	egulation(Note6)	ΔV_{LOAD}	1mA <i<sub>OUT<300mA</i<sub>		20		mV
	Output Voltage(Note 7) Temperature Coefficient		I _{OUT} =1mA		±60		ppm/°C
Stand	by Current	I _{STBY}	V _{EN} =GND, Shutdown		0.01	1	μА
EN Input	Bias Current	I _{IBSD}	V _{EN} =GND or V _{IN}			2	μΑ
EN Input	Logic Low	V _{IL}	V _{IN} =3V to 5.5V, Shutdown			0.4	V
Threshold	Logic High	V _{IH}	V _{IN} =3V to 5.5V, Start up	1.2			V
	Output Noise Voltage		10Hz to100KHz, I _{OUT} =100mA		180		μV_{RMS}
Power	f=217Hz				-75		
Supply	f=1KHz	PSRR	I _{OUT} =10mA		-71		dB
Rejection . Ratio	f=10KHz				-55		1
Therma Tem	Thermal Shutdown Temperature		Shutdown, Temp increasing		170		$^{\circ}$
	al Shutdown steresis	T _{SDHY}			30		$^{\circ}$ C

Note 4: Production test at +25°C. Specifications over the temperature range are guaranteed by design and characterization.

Note 5: Line regulation is calculated by
$$\Delta V_{LINE} = \left| \left(\frac{V_{OUT1} - V_{OUT2}}{\Delta V_{IN} \times V_{OUT (normal)}} \right) \right| \times 100$$

Where V_{OUT1} is the output voltage when V_{IN} =5.5V, and V_{OUT2} is the output voltage when V_{IN} =4.3V,

 ΔV_{IN} =1.2V. V_{OUT} (normal) =3.3V.

Note 6: Load regulation is calculated by V_{load}=Vout1-Vout2

Where V_{OUT1} is the output voltage when I_{OUT}=1mA, and V_{OUT2} is the output voltage when I_{OUT}=300mA.

Note 7: The temperature coefficient is calculated by $TC_{T_{OUT}} = \frac{\Delta V_{OUT}}{\Delta T \times V_{OUT}}$

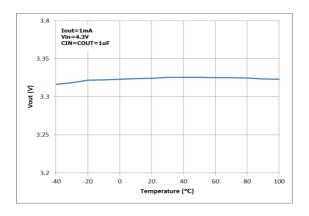
www.belling.com.cn 4 V1.2



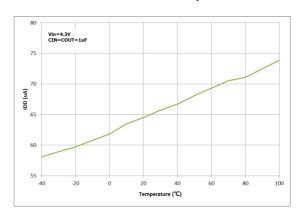
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Typical Performance Characteristics

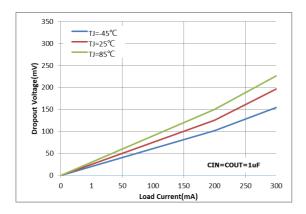
Output Voltage Vs. Temperature



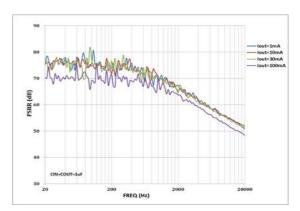
Quiescent Current Vs. Temperature



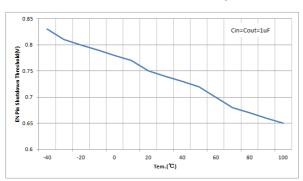
Dropout Voltage Vs. Load Current



PSRR



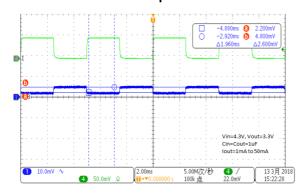
EN Pin Shutdown Threshold Vs. Temperature



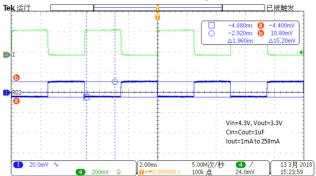


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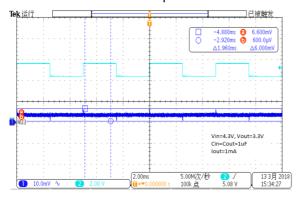
Load Transient Response



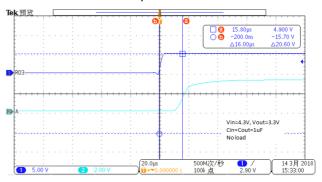
Load Transient Response



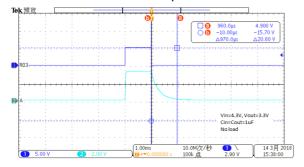
Line transient Response



Start up



EN Pin Shutdown Response







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Applications Information

Like any low-dropout regulator, the external capacitors used with the BL9161G must be carefully selected for regulator stability and performance. Using a capacitor whose value is $> 1\mu$ F on the BL9161G input and the amount of capacitance can be increased without limit. The input capacitor must be located a distance of not more than 0.5 inch from the input pin of the IC and returned to a clean analog ground. Any good quality ceramic or tantalum can be used for this capacitor. The capacitor with larger value and lower ESR (equivalent series resistance) provides better PSRR and line-transient response. The output capacitor must meet both requirements for minimum amount of capacitance and ESR in all LDOs application. The BL9161G is designed specifically to work with low ESR ceramic output capacitor in space-saving and performance consideration. Using a ceramic capacitor whose value is at least 1µF with ESR is > $25m\Omega$ on the BL9161G output ensures stability. The BL9161G still works well with output capacitor of other types due to the wide stable ESR range. Output capacitor of larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located not more than 0.5 inch from the Vout pin of the BL9161G and returned to a clean analog ground.

Enable Function

The BL9161G features an LDO regulator enable/disable function. To assure the LDO regulator will switch on; the EN turn on control level must be greater than 1.2 volts. The LDO regulator will go into the shut-

down mode when the voltage on the EN pin falls below 0.4 volts. For to protect the system, the BL9161G have a quick discharge function. If the enable function is not needed in a specific application, it may be tied to V_{IN} to keep the LDO regulator in a continuously on state.

Thermal Considerations

Thermal protection limits power dissipation in BL9161G. When the operation junction temperature exceeds 170°C, the OTP circuit starts the thermal shutdown function turn the pass element off. The pass element turns on again after the junction temperature cools by 30°C.

For continue operation, do not exceed absolute maximum operation junction temperature 125°C. The power dissipation definition in device is:

$$P_D(MAX) = (T_J(MAX) - T_A)/\theta_{JA}$$

Where T_J(MAX) is the maximum operation junction temperature 125°C, TA is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance. For recommended operating conditions specification of BL9161G, where T_J(MAX) is the maximum junction temperature of the die (125°C) and T_A is the maximum ambient temperature. The junction ambient thermal resistance (θ_{JA} is layout dependent) for SOT-23-5 package is 250°C/W. on standard JEDEC 51-3 thermal test board. The maximum power dissipation at T_A= 25°C can be calculated by following formula:



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 $P_D(MAX) = (125^{\circ}C-25^{\circ}C)/250 = 400$ mW (SOT-23-5)

The maximum power dissipation depends on operating ambient temperature for fixed $T_J(MAX)$ and thermal resistance θ_{JA} . It is also useful to calculate the junction of temperature of the BL9161G under a set of specific conditions. In this example let the Input voltage $V_{IN}=3.3V$, the output current Io=300mA and the case temperature $T_A=40^{\circ}C$ measured by a thermal couple during operation. The power dissipation for the $V_{OUT}=2.8V$ version of the BL9161G can be calculated as:

 $P_D = (3.3V-2.8V) \times 300mA + 3.6V \times 100uA$ =150mW

And the junction temperature, T_J, can be calculated as follows:

 $T_J=T_A+P_D\times\theta_{JA}=40^{\circ}C+0.15W\times250^{\circ}C/W$ =40°C+37.5°C=77.5°C< $T_J(MAX)$ =125°C

For this operating condition, T_J is lower than the absolute maximum operating junction temperature,125°C, so it is safe to use the BL9161G in this configuration.

Layout considerations

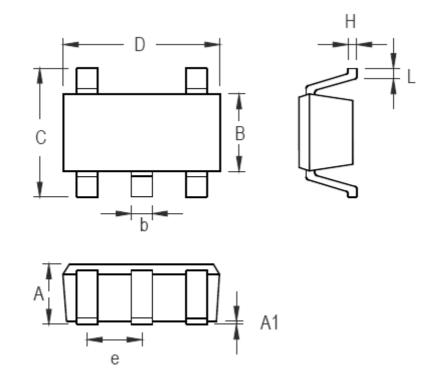
To improve ac performance such as PSRR, output noise, and transient response, it is recommended that the PCB be designed with separate ground planes for V_{IN} and V_{OUT} , with each ground plane connected only at the GND pin of the device.



300mA Ultra-low Noise, Ultra-Fast CMOS LDO Regulator

Package Description

SOT23-5

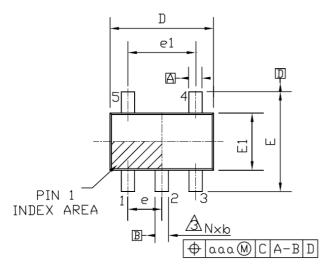


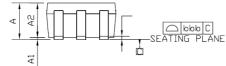
Cumbal	Dimensions Ir	Dimensions In Millimeters		nsions In Inches	
Symbol	Min	Max	Min	Max	
А	0.889	1.295	0.035	0.051	
A1	0.000	0.152	0.000	0.006	
В	1.397	1.803	0.055	0.071	
b	0.356	0.559	0.014	0.022	
С	2.591	2.997	0.102	0.118	
D	2.692	3.099	0.106	0.122	
е	0.838	1.041	0.033	0.041	
Н	0.080	0.254	0.003	0.010	
L	0.300	0.610	0.012	0.024	

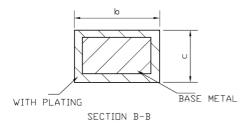


300mA Ultra-low Noise, Ultra-Fast CMOS LDO Regulator

SC70-5







GUAGE PLANE

SEATING PLANE

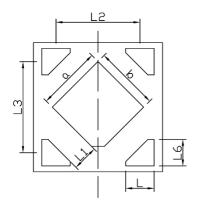
VIEW A-A

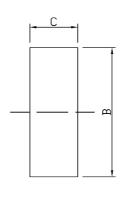
N MILLIMETERS MIN NOMAL MAX	COMMON DIMENSION						
A 0.80 − 1.10 A1 0 − 0.10 A2 0.80 0.90 1.00 A3 0.47 0.52 0.57 A4 0.33 0.38 0.43 b 0.15 − 0.30 c 0.10 − 0.25 D 1.85 2.00 2.20 e 0.65 BSC e1 1.30 BSC E 1.80 2.10 2.40 E1 1.15 1.25 1.35 L 0.10 − 0.45 L1 0.42 REF. L2 0.20 BSC θ 0° 4° 30° θ1 4° − 12° ααα 0.10	S Y	IN M	IN MILLIMETERS				
A1 0 - 0.10 A2 0.80 0.90 1.00 A3 0.47 0.52 0.57 A4 0.33 0.38 0.43 b 0.15 - 0.30 c 0.10 - 0.25 D 1.85 2.00 2.20 e 0.65 BSC e1 1.30 BSC E 1.80 2.10 2.40 E1 1.15 1.25 1.35 L 0.10 - 0.45 L1 0.42 REF. L2 0.20 BSC θ 0° 4° 30° θ1 4° - 12° ααα 0.10	B C L	MIN	NDMAL	MAX			
A2 0.80 0.90 1.00 A3 0.47 0.52 0.57 A4 0.33 0.38 0.43 b 0.15 - 0.30 c 0.10 - 0.25 D 1.85 2.00 2.20 e 0.65 BSC e1 1.30 BSC E 1.80 2.10 2.40 E1 1.15 1.25 1.35 L 0.10 - 0.45 L1 0.42 REF L2 0.20 BSC θ 0° 4° 30° θ1 4° - 12° ααα 0.10	Ъ	0.80	ı	1.10			
A3 0.47 0.52 0.57 A4 0.33 0.38 0.43 b 0.15 - 0.30 c 0.10 - 0.25 D 1.85 2.00 2.20 e 0.65 BSC e1 1.30 BSC E 1.80 2.10 2.40 E1 1.15 1.25 1.35 L 0.10 - 0.45 L1 0.42 REF. L2 0.20 BSC 0 0° 4° 30° 01 4° - 12° aaa 0.10	A1	0	ı	0.10			
A4 0.33 0.38 0.43 b 0.15 - 0.30 c 0.10 - 0.25 D 1.85 2.00 2.20 e 0.65 BSC e1 1.30 BSC E 1.80 2.10 2.40 E1 1.15 1.25 1.35 L 0.10 - 0.45 L1 0.42 REF. L2 0.20 BSC θ 0° 4° 30° θ1 4° - 12° ααα 0.10		0.80	0.90	1.00			
b 0.15 - 0.30 c 0.10 - 0.25 D 1.85 2.00 2.20 e 0.65 BSC e1 1.30 BSC E 1.80 2.10 2.40 E1 1.15 1.25 1.35 L 0.10 - 0.45 L1 0.42 REF. L2 0.20 BSC 0 0° 4° 30° 01 4° - 12° aaa 0.10		0.47	0.52	0.57			
C 0.10 - 0.25 D 1.85 2.00 2.20 e 0.65 BSC e1 1.30 BSC E 1.80 2.10 2.40 E1 1.15 1.25 1.35 L 0.10 - 0.45 L1 0.42 REF. L2 0.20 BSC 0 0° 4° 30° 01 4° - 12° aaa 0.10	Α4	0.33	0.38	0.43			
D 1.85 2.00 2.20 e 0.65 BSC e1 1.30 BSC E 1.80 2.10 2.40 E1 1.15 1.25 1.35 L 0.10 − 0.45 L1 0.42 REF. L2 0.20 BSC θ 0° 4° 30° θ1 4° − 12° ααα 0.10	b	0.15	ı				
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E1 1.15 1.25 1.35 L 0.10 - 0.45 L1 0.42 REF. L2 0.20 BSC θ 0° 4° 30° θ1 4° - 12° ααα 0.10		1	1.30 BS	С			
L 0.10 - 0.45 L1 0.42 REF. L2 0.20 BSC θ 0° 4° 30° θ1 4° - 12° ααα 0.10	Ε	1.80	2.10	2.40			
L1 0.42 REF. L2 0.20 BSC θ 0° 4° 30° θ1 4° - 12° ααα 0.10	E1	1.15	1.25	1.35			
L1 0.42 REF. L2 0.20 BSC θ 0° 4° 30° θ1 4° - 12° ααα 0.10	L	0.10	ı	0.45			
θ 0° 4° 30° θ1 4° - 12° ααα 0.10		O	.42 RE	F.			
θ1 4° - 12° ααα 0.10	L2	O	0.20 BS				
aaa 0.10	θ	°	4°	30°			
0.10	0 1	4°	-	12°			
bbb 0.10	aaa		0.10				
~~~	bbb		0.10				

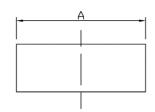


300mA Ultra-low Noise, Ultra-Fast
CMOS LDO Regulator

#### DFN1×1-4L

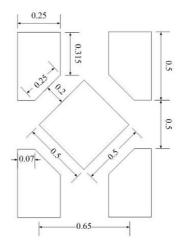






There may be slight differences in shape

Dimensions In Millimeterer							
Symbol	MIN	TYP	MAX				
Α	0.950	1.000	1.050				
В	0.950	1.000	1.050				
С	0.320	0.370	0.420				
L	0.170	0.220	0.270				
L1	0.140	0.190	0.240				
L2	0.600	0.650	0.700				
L3	0.625	0.675	0.725				
L6	0.175	0.225	0.275				
a	0.440	0.490	0.540				
b	0.440	0.490	0.540				

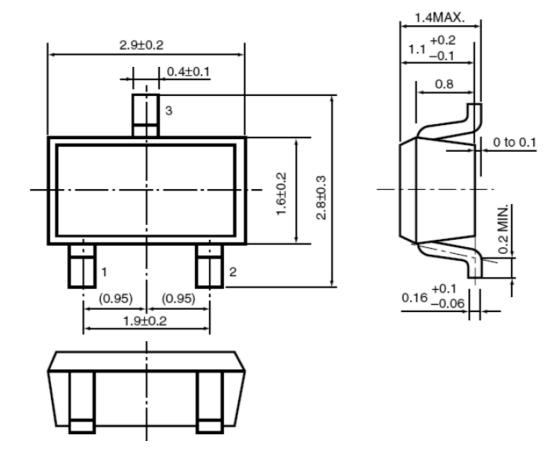


RECOMMENDED LAND PATTERN (Unit: mm)



300mA Ultra-low Noise, Ultra-Fast
CMOS LDO Regulator

#### **SOT23-3**



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